DS07-10205-1E

Resonator

Piezoelectric Resonator (4 to 20 MHz)

FAR Family (C3 series M/N type)

■ DESCRIPTION

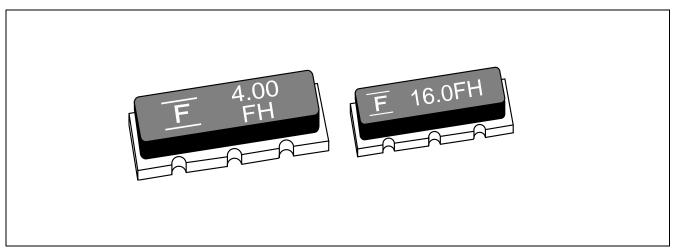
The features of the C3 series (M,N Type) resonators are compact and high stability. They are fabricated on a lithium tantalate (LitaO₃) substrate, producing resonators with ultra compact and superior stability due to the high electromechanical coupling coefficient of the material.

They include two loading capacitors inside and are housed in chip type of package for surface mount. These contribute saving mount space and reducing cost.

■ FEATURES

- High stability (Overall frequency deviation; 0.10% max)
- Ultra small package
- Wide frequency range in 4 MHz to 20 MHz
- Suitable for microcomputer clock
- Emboss-typed pack for automatic mounting
- Superior shock and vibration resistance, preventing damage during automatic mounting

■ PACKAGE



■ STANDARD CHARACTERISTICS

Series Item	C3 series	Remarks
Material	Lithium Tantalate (LiTaO ₃)	
Frequency	4 MHz to 20 MHz	
Standard frequency	See "■ Standard Frequency."	
Initial frequency deviation	+0.025% -0.035% (F), ±0.05% (G)	$\pm 0.1\%$ (J) and $\pm 0.3\%$ (K) are also available upon request.
Temperature characteristics	+0.035% -0.025% (Within -10°C to +60°C)	Reference temperature: +25°C
Capacity of built-in capacitor	20 ±8 pF (Standard)	10 ±4 pF are also available. Capacity is specified by Fujitsu, considering matching data with applied IC (mainly microcomputer).
Operating temperature	−30°C to +85°C	
Storage temperature	-40°C to +100°C	
	$1 \text{ M}\Omega$ $C_1 C_2$ FAR	Microcomputer 1/6MC74ACO4 × 2 (4 MHz to 8 MHz) 1/6TC74ACO4 × 2 (8 MHz to 20 MHz) • Vcc = 5.0 V DC • R: Resonator • C1, C2: Loading capacitors (built-in)
	Serial resonant resistance	
	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	R: Resonator Measuring equipment: Spectrum analyzer

■ STANDARD FREQUENCY

Standard frequency (kHz)	Package size	Resonant resistance		
4,000 4,194	М	$300~\Omega$ max. (Symbol: 0)		
6,000 8,000 10,000 12,000 16,000 16,934 20,000	N	150 Ω max. (Symbol: 1)		

Notes: • Fujitsu can also develop another frequency device besides standard devices within 4 MHz to 20 MHz.

• Regarding resonant resistance, maximum standard values are specified depending on frequency.

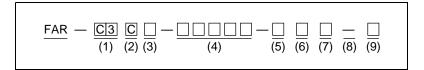
■ NOTES ON USE

- · Handle carefully.
- Solder heat resistance.
 - 5 seconds max. at +230°C (on PCB)

Recommended preheating is +150°C for one minute for avoiding giving extreme heat fluctuation to resonator.

- Avoid using resonator under condition of extreme temperature fluctuation.
- There is no specific direction in resonator mounting.
- Oscillation data must be considered in case that this resonator is used as microcomputer clock.
- Resonator is designed for reflow solder, not for flow solder.

■ PART NUMBERING SYSTEM



(1) Series

Series	Material	Capacitators		
C3	LiTaO₃	Built-in type		

(2) Package type

Symbol	Туре
С	Chip

(3) Package size

Symbol	Size				
М	$4.5\times10.0\times2.0$ mm (4.0 MHz to 5.9 MHz)				
N	$3.2\times8.0\times1.6$ mm (6.0 MHz to 20.0 MHz)				

(4) Oscillation frequency

Frequency is specified with 5-digit in kHz of unit.

Frequency	Symbol
[Example] 8.000 MHz	08000

See "■ Standard Frequency."

(5) Initial frequency deviation

Symbol	Deviation
F	+0.025% -0.035%
G	±0.05%
J	±0.1%
K	±0.3%

(6) Built-in capacitors

Symbol	Capacitor			
0	20 ±8 pF			
1	10 ±4 pF			

(7) Resonant resistance

Symbol	Resistance			
0	300 Ω max.			
1	150 Ω max.			

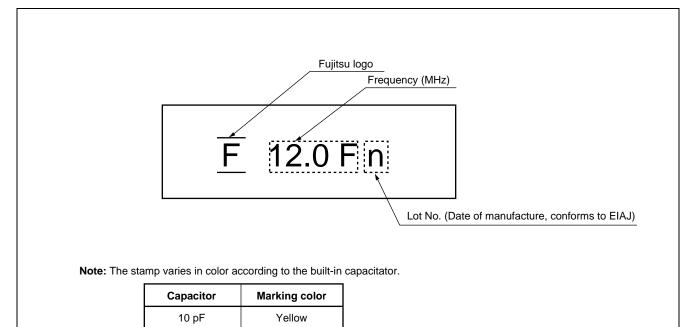
(8) Special mark

Symbol	Content			
Space	Standard device, no taping specification			
_	Standard device, with Tape & Reel			
H to Z	Serial number for custom design			

(9) Taping specification

Symbol	Content			
R	16 mm width emboss tape (3,000 pcs/reel)			

■ MARKING



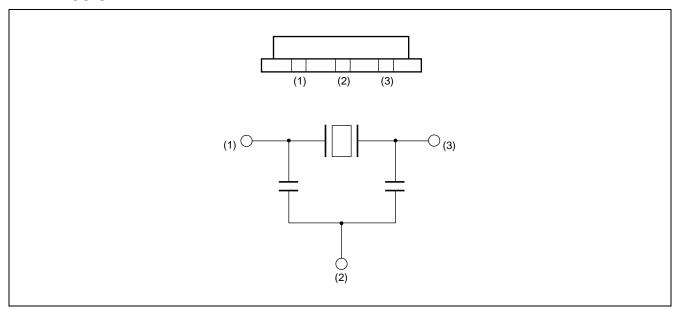
White

Data code (EIAJ standard) is specified as follows in four-year cycle.

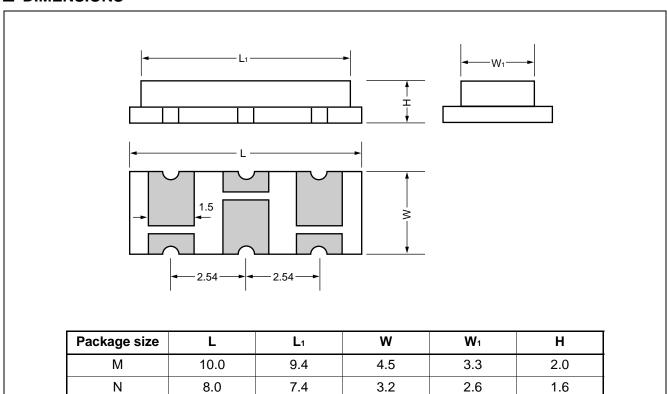
20 pF

Year	Month	Mark	Year	Month	Mark	Year	Month	Mark	Year	Month	Mark
	1	Α		1	N		1	а	2000 2004	1	n
	2	В		2	Р		2	b		2	þ
	3	С		3	Q		3	c		3	9
	4	D		4	R	1999 2003	4	d		4	r
	5	F	1998 2002	5	S		5	е		5	s
1997	6	G		6	Т		6	f		6	t
2001	7	Н		7	U		7	g		7	u
	8	I		8	V		8	h		8	u
	9	J		9	W		9	j		9	w
	10	K		10	Х		10	k		10	*
	11	L		11	Υ		11	e		11	y
	12	М		12	Z		12	m		12	3

■ PIN ASSIGNMENT

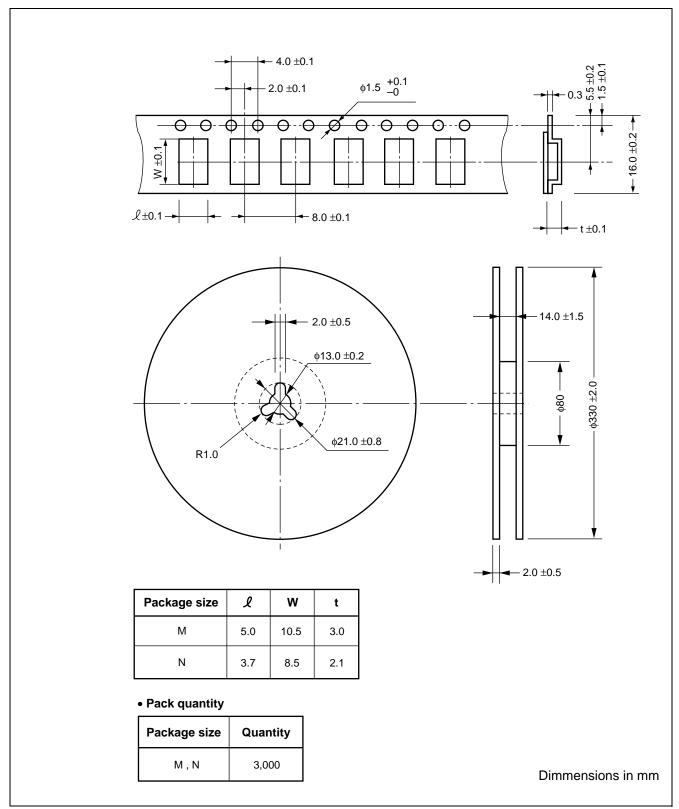


■ DIMENSIONS



Dimmensions in mm

■ TAPING FORM AND DIMENSIONS



FUJITSU LIMITED

For further information please contact:

Japan

FUJITSU LIMITED

Corporate Global Business Support Division

Electronic Devices

KAWASAKI PLANT, 4-1-1, Kamikodanaka

Nakahara-ku, Kawasaki-shi Kanagawa 211-88, Japan

Tel: (044) 754-3763 Fax: (044) 754-3329

http://www.fujitsu.co.jp/

North and South America

FUJITSU MICROELECTRONICS, INC.

Semiconductor Division 3545 North First Street San Jose, CA 95134-1804, U.S.A.

Tel: (408) 922-9000 Fax: (408) 922-9179

Customer Response Center Mon. - Fri.: 7 am - 5 pm (PST)

Tel: (800) 866-8608 Fax: (408) 922-9179

http://www.fujitsumicro.com/

Europe

FUJITSU MIKROELEKTRONIK GmbH Am Siebenstein 6-10 D-63303 Dreieich-Buchschlag Germany

Tel: (06103) 690-0 Fax: (06103) 690-122

http://www.fujitsu-ede.com/

Asia Pacific

FUJITSU MICROELECTRONICS ASIA PTE LTD #05-08, 151 Lorong Chuan New Tech Park

Singapore 556741 Tel: (65) 281-0770 Fax: (65) 281-0220

http://www.fmap.com.sg/

F9801

© FUJITSU LIMITED Printed in Japan

All Rights Reserved.

The contents of this document are subject to change without notice. Customers are advised to consult with FUJITSU sales representatives before ordering.

The information and circuit diagrams in this document presented as examples of semiconductor device applications, and are not intended to be incorporated in devices for actual use. Also, FUJITSU is unable to assume responsibility for infringement of any patent rights or other rights of third parties arising from the use of this information or circuit diagrams.

FUJITSU semiconductor devices are intended for use in standard applications (computers, office automation and other office equipment, industrial, communications, and measurement equipment, personal or household devices, etc.).

CAUTION:

Customers considering the use of our products in special applications where failure or abnormal operation may directly affect human lives or cause physical injury or property damage, or where extremely high levels of reliability are demanded (such as aerospace systems, atomic energy controls, sea floor repeaters, vehicle operating controls, medical devices for life support, etc.) are requested to consult with FUJITSU sales representatives before such use. The company will not be responsible for damages arising from such use without prior approval.

Any semiconductor devices have inherently a certain rate of failure. You must protect against injury, damage or loss from such failures by incorporating safety design measures into your facility and equipment such as redundancy, fire protection, and prevention of over-current levels and other abnormal operating conditions.

If any products described in this document represent goods or technologies subject to certain restrictions on export under the Foreign Exchange and Foreign Trade Control Law of Japan, the prior authorization by Japanese government should be required for export of those products from Japan.